# **µ-RWELLs for IDEA experiment at FCC\_ee**

M. Poli Lener on behalf of

INFN BO, Fe, LNF , To



### Future Circular Collider @ CERN



# **IDEA detector layout**



- New, innovative, cost-effective concept
  - Silicon vertex detector
- Short-drift, ultra-light wire chamber
- Dual-readout calorimeter
- Thin solenoid coil *inside* calorimeter system
- Muon system made of 3 layers of uRWELL detectors in the return yoke

```
https://pos.sissa.it/390/
```

The **IDEA detector** is a general purpose detector designed for experiments at future  $e^+e^-$  colliders. **Pre-shower detector** and the Muon system are designed to be instrumented with  $\mu$ -RWELL technology.

### IDEA— $\mu\text{-}RWELL$ for pre-shower and muon apparatus

The **IDEA detector** is a general purpose detector designed for experiments at future  $e^+e^-$  colliders. **Pre-shower detector** and the Muon system are designed to be instrumented with  $\mu$ -RWELL technology.

### **Pre-shower & Muon requirements:**

Tiles: 50x50 cm<sup>2</sup> with X-Y readout

Efficiency  $\geq$  98%

Space resolution ≤ 100 µm (Pre-shower)

≤ 400 μm (Muon)

Instrumented Surface/FEE:

130 m<sup>2</sup>, 520 det., 3×10<sup>5</sup> ch. (0.4 mm strip pitch) 1500 m<sup>2</sup>,1520 det., 5×10<sup>6</sup> ch. (1.2 mm strip pitch)

Mass production  $\rightarrow$  Technology Trasfer to Industry

FEE Cost reduction → custom made ASIC (TIGER)



G. Bencivenni et al., The micro-Resistive WELL detector: a compact spark-protected single amplification-stage MPGD, 2015 JINST 10 P02008



The **µ-RWELL** is a **resistive MPGD** composed of two elements:

- Cathode
- μ-RWELL\_PCB:

The µ-RWELL

- a WELL patterned kapton foil (w/Cu-layer on top) acting as amplification stage
- a resisitive DLC layer<sup>(\*)</sup> w/ $\rho$ ~10÷100 M $\Omega$ / $\Box$
- a standard readout PCB with pad/strip segmentation

(\*) DLC foils are currently provided by the Japan Company – BeSputter



The **"WELL"** acts as a **multiplication channel** for the ionization produced in the drift gas gap.

The **resistive stage** ensures the **spark amplitude quenching**. **Drawback:** capability to stand high particle fluxes reduced, but **largely recovered** with appropriate **grounding schemes** of the **resistive layer** 

### u-RWELL R&D for FCC\_ee

# u-RWELL R&D for FCC



IFN

# **R&D for FCC: 1D R/out**



#### Resistivity Scan @ fixed pitch



Active area= 400x50 mm2Pre-preg thickness= 50 umResistivity=  $10 \div 80 \text{ M}\Omega$ / Strip pitch= 0.4 mmStrip width = 0.150 mmRatio p/w= 2.66





(b) Strip cluster size for different HV.

RD-FCC u-RWELL, Residuals test resolution - 75ADC threshold

Ar:CO.;CF, 45:15:40

(a) Cluster charge for different HV.





(c) Tracking efficiency for different HV.

(d) Residuals width for different HV.

Same performance except the 10 M $\Omega$ / proto Efficiency knee @ 550 V,  $\sigma_x < 100$  um

**RD51 Collaboration Meeting** 

### **R&D for FCC: 1D R/out**



680

680



(c) Tracking efficiency for different HV.

(d) Residuals width for different HV.

Larger is the strip pitch, lower is the charge signal requiring a higher gain to reach full efficiency.

Efficiency knee @ 600 V &  $\sigma_x$  < 400 um for a strip pitch = 1.6 mm A high p/w ratio implies a worsening of the detector performance



Active area = 400x50 mm2 Pre-preg thickness= 50 um Resistivity= 30 M $\Omega$ / Strip pitch= 0.4-1.6 mm Strip width = 0.15 mm p/w ratio= 2.66 – 10.66

The 1D proto show very good performace @ 500 V to be compared with 2D ones (TB 2023) Efficiency knee @ 500 V &  $\sigma x < 200$  um for a strip pitch ~ 0.8 mm

# **R&D for FCC: 1D R/out**

FCC Muon

protos

CHARGE [a.u.] 2000 2000 2000

1500

1000

500

Efficiency [%] 0.8

0.6

0.4

0.2

400

400

450

.

450

Active area= 100x100 mm2 Pre-preg thickness= 20 um Resistivity= 50 M $\Omega$ / Strip pitch= 0.76 mm Strip width = 0.3 mm Ratio p/w= 2.53

2x1D uRWELL

### 2x1D performance









RWELL 2D «COMPASS» [\*]

The «COMPASS» R/out requires higher gas gain due to the coupling of the X and Y R/out strips. Good perfomance No easy optimization of the charge sharing on X-Y views

(\*) Y. Zhou et al. NIMA 927 (2019) 31

6/12/2023

11



The «COMPASS» R/out requires higher gas gain due to the coupling of the X and Y R/out strips Good perfomance No easy optimization of the charge sharing on X-Y views

(\*) Y. Zhou et al. NIMA 927 (2019) 31 6/12/2023

**RD51 Collaboration Meeting** 



The «COMPASS» R/out requires higher gas gain due to the coupling of the X and Y R/out strips Good perfomance No easy optimization of the charge sharing on X-Y views

(\*) Y. Zhou et al. NIMA 927 (2019) 31

N.2 u-RWELLS 1D (2x1D) Y-strips Drift gap Common Cathode Drift gap

This option centainly allows to work at **lower gas gain** wrt the «COMPASS» R/out (X-Y r/out are decoupled)

X-strips

 $\rightarrow$  TB2022 results:

- **IDEA pre-shower:** Efficiency knee @ 550 V,  $\sigma_{\rm x}$  < 100 um with 0.4 mm strip pitch for the

- **IDEA Muon:** Efficiency knee @ 600 V &  $\sigma_x$  < 400 um for a strip pitch = 1.6 mm

6/12/2023

**RD51 Collaboration Meeting** 



The «COMPASS» R/out requires higher gas gain due to the coupling of the X and Y R/out strips Good perfomance No easy optimization of the charge sharing on X-Y views

(\*) Y. Zhou et al. NIMA 927 (2019) 31



This option centainly allows to work at **lower gas gain** wrt the «COMPASS» R/out (X-Y r/out are decoupled)

 $\rightarrow$  TB2022 results:

- **IDEA pre-shower:** Efficiency knee @ 550 V,  $\sigma_x$  < 100 um with 0.4 mm strip pitch for the

- **IDEA Muon:** Efficiency knee @ 600 V &  $\sigma_x$  < 400 um for a strip pitch = 1.6 mm

**RD51 Collaboration Meeting** 



The charge sharing structures: the charge transfer and charge sharing using capacitive coupling between a stack of layers of pads and the r/out board.

This technique offers the possibility to reduce the FEE channels, but the total charge is divided between the X & Y r/out (similar to the «COMPASS» R/out)

(\*) K. Gnanvo et al. NIMA 1047 (2023) 167782



The «COMPASS» R/out requires higher gas gain due to the coupling of the X and Y R/out strips Good perfomance No easy optimization of the charge sharing on X-Y views

(\*) Y. Zhou et al. NIMA 927 (2019) 31 6/12/2023



This option centainly allows to work at **lower gas gain** wrt the «COMPASS» R/out (X-Y r/out are decoupled)

 $\rightarrow$  TB2022 results:

- **IDEA pre-shower:** Efficiency knee @ 550 V,  $\sigma_{\rm x}$  < 100 um with 0.4 mm strip pitch for the

- IDEA Muon: Efficiency knee @ 600 V &  $\sigma_{\rm x}$  < 400 um for a strip pitch

**RD51 Collaboration Meeting** 

= 1.6 mm



The charge sharing structures: the charge transfer and charge sharing using capacitive coupling between a stack of layers of pads and the r/out board.

This technique offers the possibility to reduce the FEE channels, but the total charge is divided between the X & Y r/out (similar to the «COMPASS» R/out) The **TOP layout** centainly allows to work at **lower gas gain** wrt the «COMPASS» r/out (X-Y r/out are decoupled)

→ X coordinate on the TOP of the amplification stage introduces same dead zone in the active area

(\*) K. Gnanvo et al. NIMA 1047 (2023) 167782





Drift gap



CS Readout board



Active area=  $100 \times 100 \text{ mm2}$ Resistivity=  $50 \text{ M}\Omega$ / Strip pitch= 1.2 mmStrip width = 1.1 mmSeveral layer between DLC and R/out

6/12/2023



Unift gap X-strips X coordinate on the TOP of the amplification stage



Active area=  $100 \times 100 \text{ mm2}$ Resistivity=  $50 \text{ M}\Omega$ / Strip pitch= 0.8 mmStrip width = 0.7 mmDead zone (TOP) ~ 15%Pre-preg thickness= 70 um

#### **RD51 Collaboration Meeting**

**16** J

### **R&D for FCC: 2D R/out**

An ugual charge sharing on the X-Y coordinates is shown for both 2D r/out



### **R&D for FCC: 2D R/out**

An ugual charge sharing on the X-Y coordinates is shown for both 2D r/out

#### TOP r/o:

- The total charge isn't divided between X & Y view;
- Efficiency knee @ 500 V (such as 1D proto);
- Low efficiency plateau (~70%) due to dead zone
- Cluster Size does not change on X (TOP layer), while changing on the Y (due to the DLC spread);
- **Digital spatial resolution** on the X (Strip size ~ 1.5), strip Size>, improving on the Y (due to DLC spread)



650

HV [V]

650

HV [V]

### **R&D for FCC: 2D R/out**

An ugual charge sharing on the X-Y coordinates is shown for both 2D r/out

### TOP r/o:

- The total charge isn't divided between X & Y view;
- Efficiency knee @ 500 V (such as 1D proto);
- Low efficiency plateau (~70%) due to dead zone
- Cluster Size does not change on X (TOP layer), while changing on the Y (due to the DLC spread);
- Digital spatial resolution on the X (Strip size ~ 1.5), strip Size>, improving on the Y (due to DLC spread)

### CS r/o:

- The total charge is divided between X & Y view;
- Efficiency knee @ 600 V;
- High efficiency plateau (~95%)
- Cluster size increase to 4 strips (Charge Sharing mechanism work)
- Spatial resolution improves at higher gain reaching 150 um with a strip pitch of 1.2 mm



### **Status and plans 2023**

The 2023 program can be summarized in the following points:

- Finalization of the TB 2022 analysis (NA H8C, 4-20 October 2022) with μ-RWELL prototypes with 1D strip readout:
  100x100 mm2 area attiva & strip pitch 0.76 mm
  - 50x400 mm2 area attiva & strip pitch 0.4÷1.6 mm
- ✓ **Production of \mu-RWELL with** readout a strip 2D (100x100mm2 active area) the so called:
  - TOP r/out strip pitch 0.76 mm
  - Charge Sharing r/out strip pitch 1.2 mm
- ✓ Beam Test (NA H8C, 14-28 giugno 2023) of the previous layouts 2D. The test has been performed with the APV25
- Prototypes production 500x500 mm2 active area: layout TOP r/o with strip pitch of 1.2 mm (in order to minimize the dead area), while for the CS r/o, we do not consider necessary readout optimizations. The prorotypes will be ready for gen/feb-24. Test @LNF with X-ray & cosmic and afterwards a TB are foreseen.

**Finalization of the TB 2023 analysis (**NA – H8C, 14-28 giugno 2023) with **μ-RWELL proto with 2D strip** readout. Comparison of the 2D performance: proto layout 2D (CS & TOP) vs proto layout 2x1D

### **2024 Program**

The 2024 program will be foreseen the following items:

- 1. Study gas gain optimization with different geometry of the amplification stage (pitch well, external/internal well diameters) with 100x100 mm2 prototypes. These studies have been performed with GEM detector but never with uRWELL $\rightarrow$  with a reduction of the well pitch from 140 µm to 90 µm, a possible increase of the gas gain of about 2 is foreseen
- 2. Production of N.2 500x500 mm2 prototypes (second half of 2024): the choice of 2D layout will be based on the results obtained in the previous test. Test @LNF with X-ray & cosmic (with tracking system) will be performed.
- **3. Continuation** of testing of the **μRWELL production** processes at **ELTOS /CERN** and **DLC machine** at CERN (see Gianni and Gianfranco talks on Thursday)

### Summary

- The  $\mu$ -RWELL is becoming a mature device, also thanks to the technology spread that is giving an important boost to its development.
  - It is also considered for an upgrade of the LHCb Muon apparatus and for the spectrometer of CLAS12 Jlab (White paper for Snowmass), EIC, X17 @nTOF
- Preshower and muon detectors designed with the μ-RWELL technology
  - Studies aimed at defining the best DLC resistivity and strip pitch for the requested spatial resolution for preshower and muon system
  - % Good 2D  $\mu$  -RWELL prototype performance has been measured and layout optimization has been adopted
  - % Production of the  $\mu\textsc{-}RWELL$  layouts with the final active area
  - Continue partnership with ELTOS (preparation) and CERN (finalization) to complete technology transfer
- Ready for the final design for next FCC-ee descriptive document (2025-2027)

ĕ





	Phone: 77500 or 704	175
E10 3.3 E10	Comments (01–Nov–2021 13:29:30) Monday 01/11: Scrubbing started	



# Thanks for your attention

**RD51 Collaboration Meeting** 

## spare slides

### Capacitive-sharing readout: Principe & Motivation (K.GNAVO)

#### Principe of capacitive-sharing readout structures:

- ♦ Vertical stack of pads layers ⇒ Transfer of charge from MPGD via capacitive coupling
- A given arrangement of the pads position from one layer to the layer underneath as well as the doubling in size of the pad pitch allows:
  - Transverse sharing of the charges between neighboring pads of the layer (i+1)
    from vertical charged transfer from layer (i) through capacitive coupling
  - Principle of transverse charge-sharing through capacitive coupling i.e.,
    capacitive- sharing is illustrated on the cross-section sketch on the left
- The scheme preserves of the position information i.e. spatial resolution with large readout strips or pads: Goal 50 μm for 1-mm strip r/o and 150 μm for 1 cm<sup>2</sup> pad r/o
- Basic proof of concept established with 800 µm X-Y strip

#### Motivation & some key facts of capacitive-sharing readout:

- Develop high performance & low channel count readout structures for MPGDs:
- Reduce the number of readout electronic channels for large area MPGDs
- Low-cost technology for large area standard PCB fabrication techniques



